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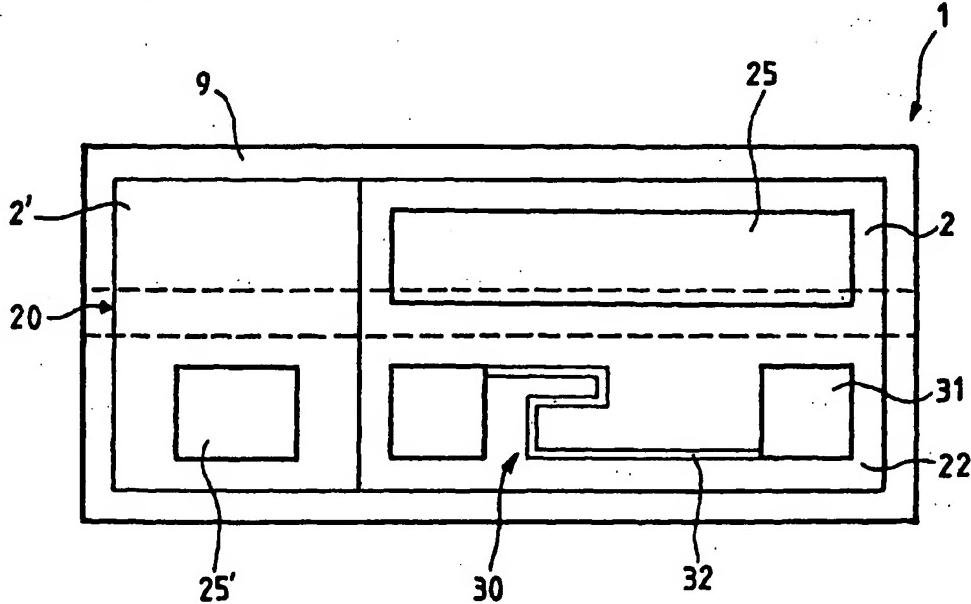
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(54) Title: INTEGRATED THERMAL SENSOR FOR OPTOELECTRONIC MODULES



(57) Abstract: An optoelectronic module comprising at least one optical component placed on a support, said component comprising an active optical layer and at least one confinement layer which carries at least one electrical contact, wherein said module further comprises a thermal sensor comprising a temperature-dependent resistive material which extends over the confinement layer of the optical component, at the side of the electrical contact of said component.

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